

# Silicon Schottky Barrier Diode

#### **Features**

- Small Surface Mounting Type
- Ideal for Automated Placement
- Ultrafast Reverse Recovery Time
- High Current Capability
- Low Forward Voltage Drop
- High Surge Capability
- RoHS Compliant

### **Applications**

- Rail to rail ESD protection
- Overshoot and undershoot switching control
- Mobile phones and accessories
- Video game consoles connector ports
- Free Wheelin

#### **Mechanical Characteristics**

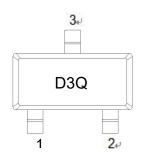
- Package: SOT-23
- Ideal for Automated Placement
- Case Material: "Green" Molding Compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020





Marking: D3Q

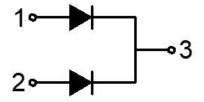
**SOT-23** 



Pin definition



#### **Epuivalent circuit**





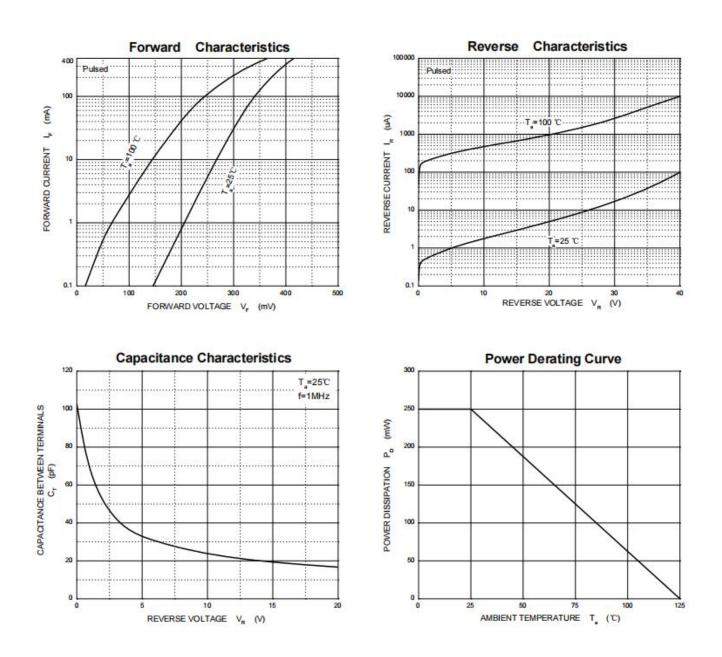
Absolute Maximum Ratings (TA=25°C unless otherwise noted)			
Parameter	Symbol	Limit	Unit
Reverse Voltage (Repetitive Peak)	V <sub>RRM</sub>	40	V
Reverse Voltage (RMS)	V <sub>R(RMS)</sub>	40	V
DC reverse voltage	V <sub>R</sub>	28	V
Continuous Forward Current	Ι <sub>Ο</sub>	400	mA
Non-RepetitivePeakForwardSurge Current@t=8.3ms	I <sub>FSM</sub>	2	A
Power Dissipation	P <sub>D</sub>	250	mW
Thermal Resistance Junction to Ambient(Typ)	$R_{\theta JA}$	400	°C <b>/W</b>
Junction Temperature	TJ	-55 ~ +125	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C

Electrical Specifications (TA=25°C unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Breakdown Voltage	$V_{BR}$	I <sub>R</sub> =100uA	25			V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =25V			70	uA
Forward Voltage		I <sub>F</sub> =10mA			0.33	V
	VF	I <sub>F</sub> =200mA			0.56	V



### **Ratings and Characteristics Curves**

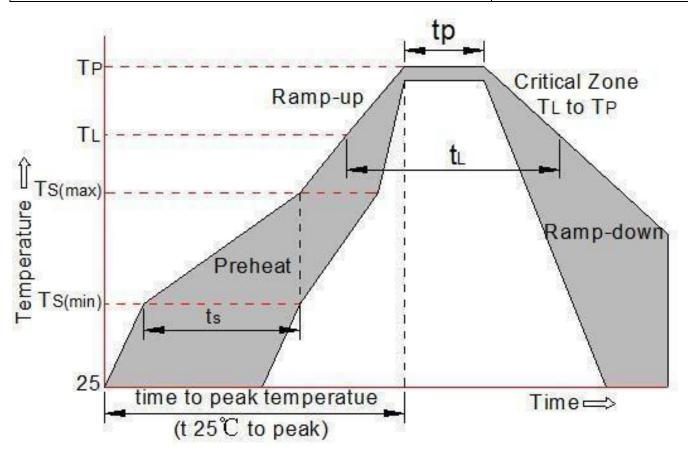
(TA = 25°C unless otherwise noted)





### **Soldering Parameters**

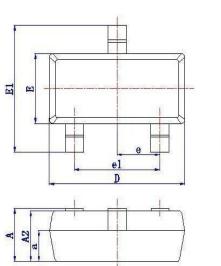
Reflow Condition		Pb -Free assembly (see as bellow)	
	-Temperature Min (T <sub>s(min)</sub> )	+150 ℃	
Pre Heat	-Temperature Max(T <sub>s(max)</sub> )	<b>+200</b> ℃	
	-Time (Min to Max) (ts)	60 -180 secs.	
Average	ramp up rate (Liquid us Temp (T L) to peak)	3 ℃ /sec. Max	
	Ts(maxt)o T L- Ramp -up Rate	3 ℃ /sec. Max	
Reflow	-Temperature(T L) (Liquidus)	+217 ℃	
	-Temperature(t L)	60 -150 secs.	
Peak Temp (T p)		+260(+0/ -5) ℃	
Time within 5 $\degree$ C of actual Peak Temp (tp)		30 secs. Max	
	Ramp -down Rate	6 ℃ /sec. Max	
	Time 25 ℃ to Peak Temp (T P)	8 min. Max	
	Do not exceed	<b>+260</b> ℃	

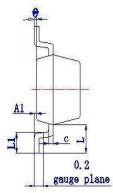




## Package Outline Dimensions

millimeters





	Dimensional		
Symbol	Millimeters		
	min	max	
A	0.9	1.15	
A1	0	0.1	
A2	0.9	1.05	
а	(0.6)		
D	2.8	3.0	
E	1.2	1.4	
E1	2.25	2.55	
е	(0.95)		
e1	1.8	2.0	
b	0.3	0.5	
С	0.08	0.15	
L	(0.55)		
L1	0.3	0.5	
θ	0°	8°	

### **Revision History**

Document Version	Date of release	Description of changes
Rev.A	2022.05.10	First issue



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